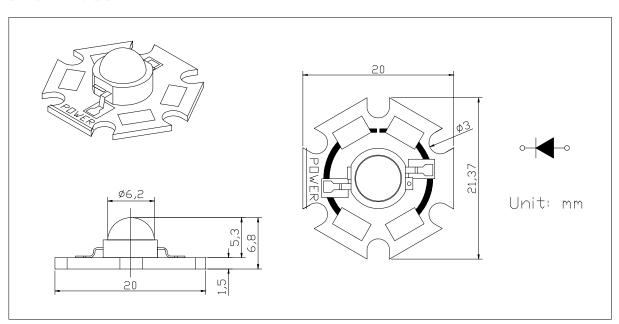


3W HIGH POWER LED (STAR Ⅲ) W081F

Features	Applications				
* Long operating life	* Reading lights (car, bus, aircraft)				
* Highest flux	* LCD Backlights/light Guides				
* Available in White:2500K-25000K	* Fiber optic alternative/ Decorative Entertainment				
* Lambertian radiation pattern	* Mini-accent/Up lighters/Down lighters/ Orientation				
* More energy efficient than incandescent and most	* Indoor/Outdoor commercial and Residential				
halogen lamps	Architectural				
* Low voltage DC operated	* Cove/Under shelf/Task				
* Cool beam, safe to the touch	* Bollards/Security/Garden				
* Instant light (less than 100ns)	* Portable (flashlight, bicycle)				
* Fully dimmable	* Edge-lit signs (Exit, point of sale)				
* No UV	* Automotive Exit (Stop-Tail-Turn,CHMSL, Mirror				
	Side Repeat)				
* Superior ESD protection	* Traffic signaling / Beacons / RailCrossing and				
	Wayside				
* Eutectic die bonding					
* RoHS compliant					

PACKAGE

Item:X081F





Typical Optical/ Electrical Characteristics @TJ=25℃

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=700mA		3.55	3.99	V
Reverse Current	IR	VR=5v			50	uA
50% Power Angle	201/2	IF=700mA	40		80	deg
Luminous Intensity V	φV	IF=700mA	113.6		147.7	lm
Luminous Intensity W	φV	IF=700mA	147.7		192	lm
Recommend Forward Current	IF			700		mΑ
Chromaticity	Tc	IF=700mA	5000		10000	k
Thermal Resistance, Junction to Case	RJP	IF=700mA		10		°C/w

Notes:

- 1. Tolerance of measurement of forward voltage±0.1V.
- 2. Tolerance of measurement of peak Wavelength±2.0nm.
- 3. Tolerance of measurement of luminous intensity±15%.

Absolute Maximum Rating

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	lF	700	mA
Peak Forward Current*	IFP	1200	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	3000	mW
Electrostatic discharge	Esp	±4500	V
Operation Temperature	Topr	-40~+80	$^{\circ}\!\mathbb{C}$
Storage Temperature	Тѕтс	-40~+100	$^{\circ}\!\mathbb{C}$
Lead Soldering Temperature*	TsoL	Max. 260°C for 3sec Max.	

- *IFP Conditions : Pulse Width≤10msec duty≤1/10
- * All high power emitter LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the high power products for more than 5 seconds without a appropriate heat dissipation equipment.
- * Re-flow, wave peak and soak- stannum soldering etc.is not suitable for this products.
- * Suggest to solder it by professional high power LED soldering machine.
- * Can use invariable-temperature searing-iron with soldering condition:≤260 degree less than 3 seconds.



Typical Optical/Electrical Characteristics Curves (TJ=25°C Unless Otherwise Noted)

Fig 1. Relative Luminous FLux vs. Forward Current

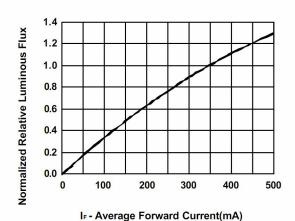
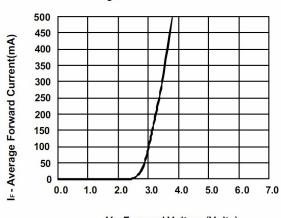
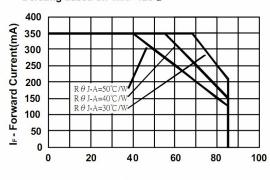


Fig 2. Forward Current vs. Forward Voltage



V_F - Forward Voltage(Volts)

Fig 3. Maximum Forward Current vs. Ambient Temperature.
Derating based on TJMAX=120°C



T_A - Ambient Temperature (°C)

Fig 4. Relative Light Output vs. Junction Temperature

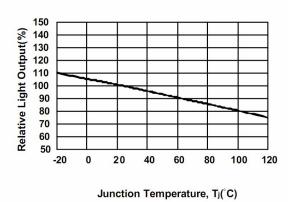


Fig 5. Relative Spectral Power Distribution vs. Wavelength

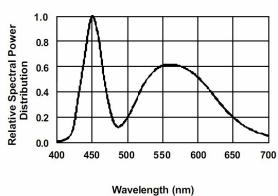
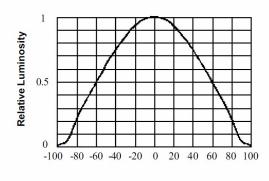


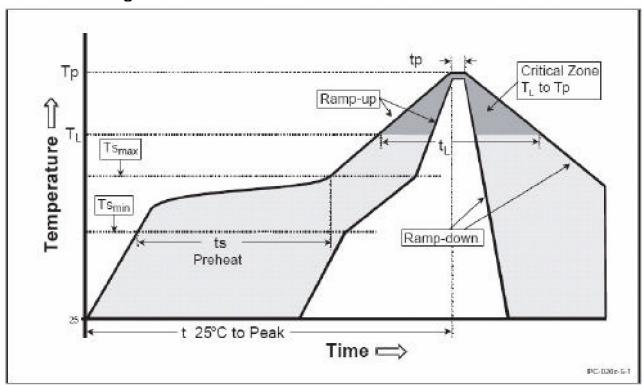
Fig 6. Relative Luminosity vs. Radiation Angle



Radiation Angle(Degrees)



Reflow Soldering Characteristics



Profile Feature	Pb-Free Assembly
Preheat	
- Temperature Min (Tsmin)	60-180 seconds
- Temperature Max (Tsmax)	150 °C
- Time (tsmin to tsmax)	200 °C
- Temperature (TL)	
- Time (tL)	60-150 seconds
Time maintained above:	217 °C
Peak/Classification Temperature (Tp)	260 °C
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Notes

1. All temperatures refer to Solder Pad